

## Power Surface Mount Schottky Rectifier (15V, 60Amp)

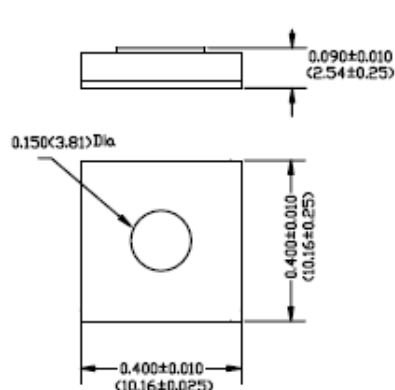
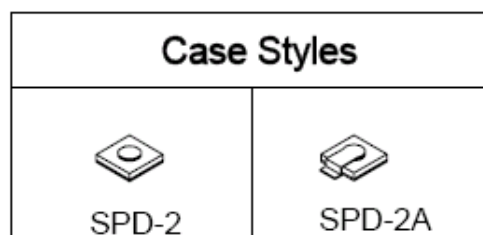
### Applications:

- Switching power supply • Redundant power subsystems • Reverse battery protection
- Converters • Many other high current AC/DC power supplies

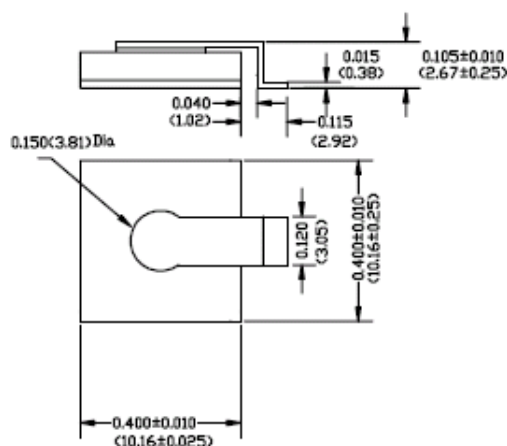
### Features:

- 100 °C T<sub>J</sub> operation
- Low forward voltage drop
- High surge capacities
- High frequency operation
- Guaranteed reverse avalanche capability
- Low profile surface mount package
- This is a Pb - Free Device
- All SMC parts are traceable to the wafer lot
- Additional testing can be offered upon request

### Mechanical Dimensions: In Inches / mm



**SPD-2**



**SPD-2A**



Suffix "R" Denotes Reversed Polarity

**Maximum Ratings:**

Characteristics	Symbol	Condition	Max.	Units
Peak Inverse Voltage	$V_{RWM}$	-	15	V
Max. Average Forward	$I_{F(AV)}$	50% duty cycle, rectangular wave form	60	A
Max. Peak One Cycle Non-Repetitive Surge Current (per leg)	$I_{FSM}$	8.3 ms, half Sine pulse	860	A

**Electrical Characteristics:**

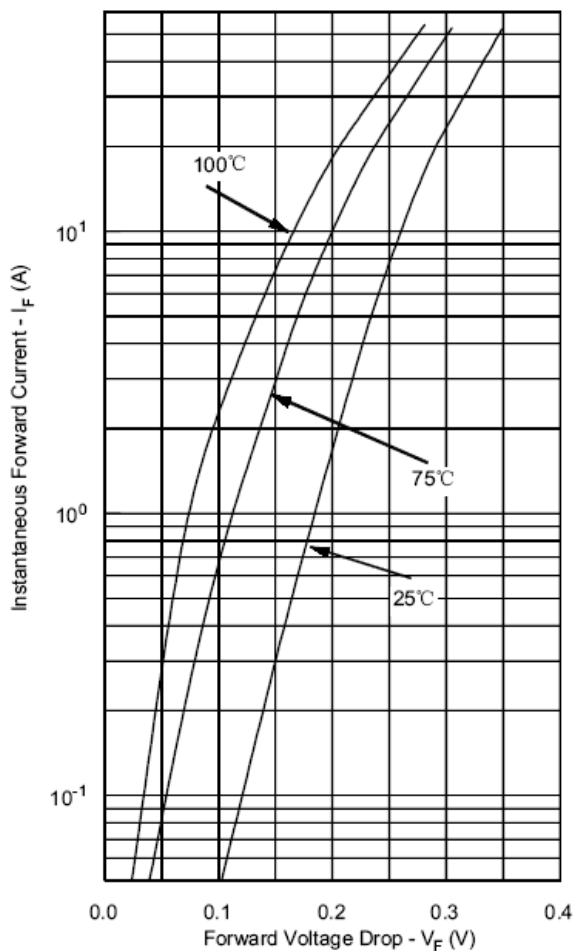
Characteristics	Symbol	Condition	Max.	Units
Max. Forward Voltage Drop*	$V_{F1}$	@ 60A, Pulse, $T_J = 25\text{ }^\circ\text{C}$	0.41	V
	$V_{F2}$	@ 60A, Pulse, $T_J = 75\text{ }^\circ\text{C}$	0.37	V
Max. Reverse Current (per leg) *	$I_{R1}$	@ $V_R = \text{rated } V_R$ , Pulse, $T_J = 25\text{ }^\circ\text{C}$	20	mA
	$I_{R2}$	@ $V_R = \text{rated } V_R$ , Pulse, $T_J = 100\text{ }^\circ\text{C}$	1000	mA
Max. Junction Capacitance (per leg)	$C_J$	@ $V_R = 5\text{V}$ , $T_C = 25\text{ }^\circ\text{C}$ $f_{SIG} = 1\text{MHz}$	3600	pF

\* Pulse Width < 300 $\mu\text{s}$ , Duty Cycle <2%

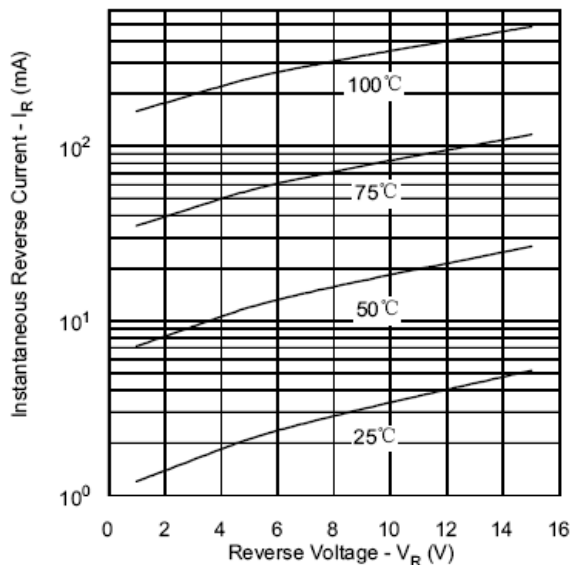
**Thermal-Mechanical Specifications:**

Characteristics	Symbol	Condition	Specification	Units
Max. Junction Temperature	$T_J$	-	-55 to +125	$^\circ\text{C}$
Max. Storage Temperature	$T_{stg}$	-	-55 to +100	$^\circ\text{C}$
Maximum Thermal Resistance Junction to Case	$R_{\theta JC}$	DC operation	0.37	$^\circ\text{C/W}$
Case Style	SPD-2/A			

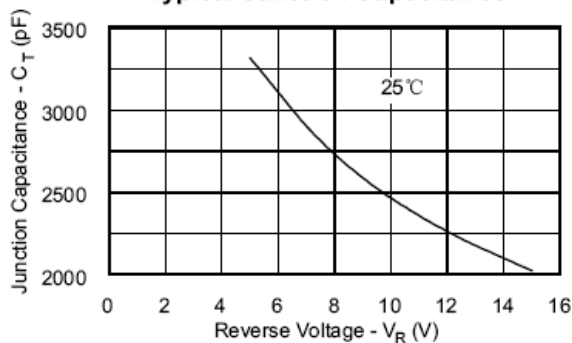
**Typical Forward Characteristics**



**Typical Reverse Characteristics**



**Typical Junction Capacitance**



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